

AIVR 2024

2024 8th International Conference on Artificial Intelligence and Virtual Reality

Fukuoka, Japan during July 19–21, 2024

CALL FOR PAPERS



System components
Virtual reality platforms
AI platforms for VR/AR
Cloud-based platforms



Content creation and modelling
Generation of immersive environments and
virtual worlds
Environments for gaming, simulation, training



AI technologies
Search
Planning
Reasoning
Cognitive aspects, perception, user behaviour
Natural language processing
Interactions / interactive and responsive
environments
Interactions / interactive and responsive
environments
Applications and use cases


KEY DATES

Deadline for Paper Submission: March 25, 2024
Notification of Acceptance: April 25, 2024
**Deadline for Registration and Camera Ready
Submission:** May 10, 2024

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PUBLICATION

All accepted papers will appear in the conference proceedings published by Springer-Verlag in One volume of Springer Book Series Smart Innovation, System and Technologies (SIST). The book series is indexed by SCOPUS, EI Compendex, INSPEC, WTI Frankfurt eG, zbMATH, Japanese Science and Technology Agency (JST), SCImago, DBLP. All books published in the series are submitted for consideration in Web of Science.

SUBMISSION

Each paper must be submitted via the Online Submission System after being prepared by following the Springer Template Specific Template (LaTeX Template or Microsoft Word Template) and be subject to both review and editing.

*Paper length should be longer than 10 pages in Springer style format, if not satisfied, should not be accepted before reviewing.

OUR HISTORY

AIVR2022 proceedings | Published by Springer-SIST, Volume 330 | Indexed by EI Compendex, Scopus
AIVR2021 proceedings | Published by ACM ICPS | Indexed by EI Compendex and Scopus.
AIVR2020 proceedings | Published by ACM ICPS | Indexed by EI Compendex and Scopus.
AIVR2019 proceedings | Published by ACM ICPS | Indexed by EI Compendex and Scopus.
AIVR2018 proceedings | Published by ACM ICPS | Indexed by EI Compendex and Scopus.